

# SJTA12N60C

 $I_{D}$ 

12A

D

s

Lead Free Package and Finish

R<sub>DS(ON)</sub>(Typ.)

0.28Ω

TO-220F

Packages Not to Scale

# Super-Junction MOSFET

# **Applications:**

- Adaptor
- Charger
- •SMPS

#### Features:

- RoHS Compliant
- . Low ON Resistance
- .Low Gate Charge
- •Peak Current vs Pulse Width Curve
- Inductive Switching Curves

#### **Ordering Information**

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PART NUMBER	BRAND						
SJTA12N60C	TO-220F	IPS					

#### Absolute Maximum Ratings T<sub>C</sub>=28

# $T_C$ =25 °C unless otherwise specified

G DS

Pb

 $V_{DSS}$ 

600V

Symbol	Parameter	SJTA12N60C	Units
V <sub>DSS</sub>	Drain-to-Source Voltage	600	V
I <sub>D</sub>	Continuous Drain Current	12	A
I <sub>DM</sub>	Pulsed Drain Current, V <sub>GS</sub> @10V (NOTE *2)	36	A
D	Power Dissipation	31.3	W
P <sub>D</sub>	Derating Factor above 25°C	0.25	<b>W/℃</b>
V <sub>GS</sub>	Gate-to-Source Voltage	±30	V
E <sub>AS</sub>	Single Pulse Avalanche Energy(L=10mH)	240	mJ
E <sub>AR</sub>	Avalanche Energy ,Repetitive (NOTE *2)	0.32	mJ
I <sub>AR</sub>	Avalanche Current (NOTE *2)	4	A
TL	Maximum Temperature for Soldering	300	
$T_{\rm J}$ and $T_{\rm STG}$	Operating Junction and Storage Temperature Range (NOTE *1)	150,-55 to150	°C

#### **Thermal Resistance**

Symbol	Parameter	Тур.	Max.	Units	Test Conditions
р	Junction-to-Case				Water cooled heatsink, P <sub>D</sub> adjusted for a
R <sub>θJC</sub>	Junction-to-Case	<b>4</b> °C∕₩	<b>4</b> °C <i>/</i> ₩		peak junction temperature of +150℃.
R <sub>0JA</sub>	Junction-to-Ambient		80		1 cubic foot chamber, free air.

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#### **OFF Characteristics** $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	600			V	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA
I <sub>DSS</sub>	Drain-to-Source Leakage Current			1		V <sub>DS</sub> =600V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃
				100	μA	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V TJ=150℃
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			+100	<b>n</b> A	$V_{GS}$ =+30V
	Gate-to-Source Reverse Leakage			-100	nA	V <sub>GS</sub> = -30V

**ON Characteristics**  $T_J=25^{\circ}C$  unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
D	StaticDrain-to-Source		0.00	0.2	0	V <sub>GS</sub> =10V, I <sub>D</sub> =6A
R <sub>DS(ON)</sub>	On-Resistance(NOTE *3)		0.28	0.3	Ω	
V <sub>GS(TH)</sub>	Gate Threshold Voltage	2.5		4	V	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$
<b>g</b> <sub>fs</sub>	Forward Transconductance(NOTE *3)		7.8		S	V <sub>DS</sub> =10V, I <sub>D</sub> =6A

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
C <sub>iss</sub>	Input Capacitance		700			(1 - 0)(1) - 0(1)
C <sub>oss</sub>	Output Capacitance		110		pF	$V_{GS}$ = 0V, $V_{DS}$ = 50V f =1.0MHz
C <sub>rss</sub>	Reverse Transfer Capacitance		7			
Qg	Total Gate Charge		17			
Q <sub>gs</sub>	Gate-to-Source Charge		4		nC	I <sub>D</sub> =12A,V <sub>DD</sub> =480V V <sub>GS</sub> = 10V
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		6			

#### Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
t <sub>d(ON)</sub>	Turn-on Delay Time		12		- ns	V <sub>DD</sub> =400V, I <sub>D</sub> =12A, V <sub>G</sub> =10V R <sub>G</sub> =25Ω
t <sub>rise</sub>	Rise Time		12			
t <sub>d(OFF)</sub>	Turn-Off Delay Time		110			
t <sub>fall</sub>	Fall Time		11			

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Source-Drain Diode Characteristics	Tc=25℃ un
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Tc=25℃ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
1.	Continuous Source Current			12	А	
IS	(Body Diode)			12	A	T <sub>C</sub> =25℃
1	Maximum Pulsed Current			36	А	
I <sub>SM</sub>	(Body Diode)					
V <sub>SD</sub>	Diode Forward Voltage			1.2	V	I <sub>SD</sub> =12A, V <sub>GS</sub> =0V
t <sub>rr</sub>	Reverse Recovery Time		280		ns	I <sub>F</sub> = I <sub>S</sub>
Q <sub>rr</sub>	Reverse Recovery Charge		2.8		uC	di/dt=100A/us

Notes:

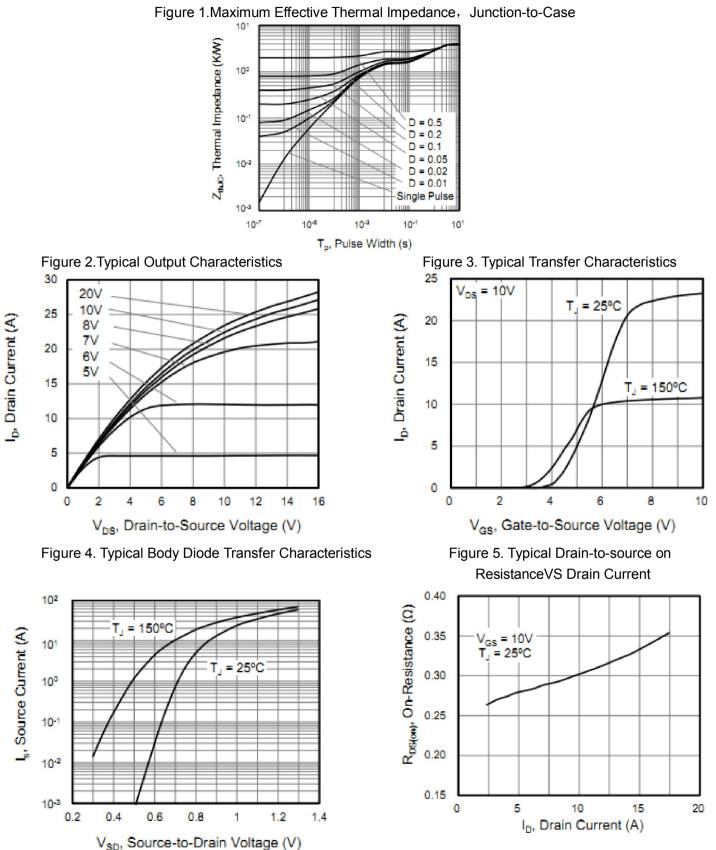
\*1. T<sub>J</sub> = +25  $^\circ \rm C$  to +150  $^\circ \rm C$  .

\*2. Repetitive rating; pulse width limited by maximum junction temperature.

\*3. Pulse width <  $380\mu$ s; duty cycle < 2%.



#### **Characteristics Curve:**

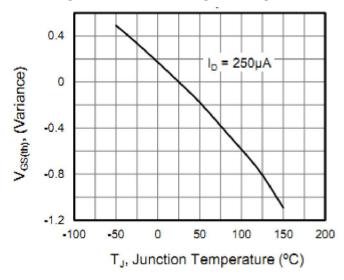




104 Capacitance (pF) 10<sup>3</sup> C Coss 10<sup>2</sup> 10<sup>1</sup> Cree V<sub>GS</sub> = 0 = 1MHz 100 20 30 40 50 60 70 n 10 V<sub>DS</sub>, Drain-to-Source Voltage (V)

Figure 6. Capacitance VS Drain-to-Source Voltage

Figure 8. Threshold Voltage VS Temperature



12 V<sub>GS</sub>, Gate-to-Source Voltage (V) 10 V<sub>DD</sub> = 120V 8 V<sub>DD</sub> = 480V 6 4 2 0 0 5 10 15 20 25 Q<sub>o</sub>, Total Gate Charge (nC)

Figure 9. on-Resistance VS Temperature

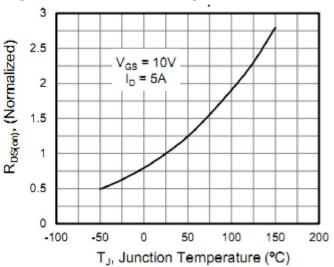
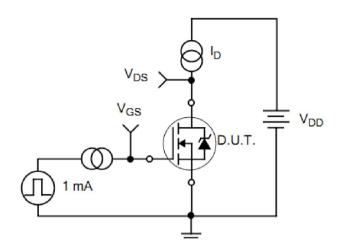


Figure 7. Gate Charge VS Gate-to-Source Voltage



# **Test Circuits and Waveforms**



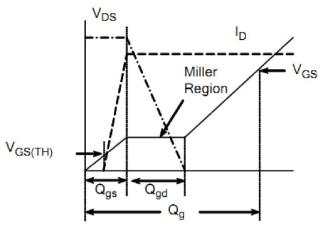
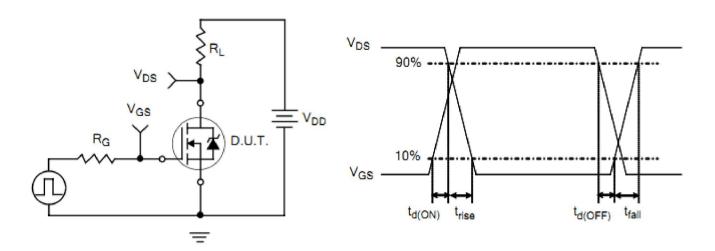
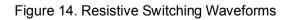


Figure 11. Gate Charge Test Circuit

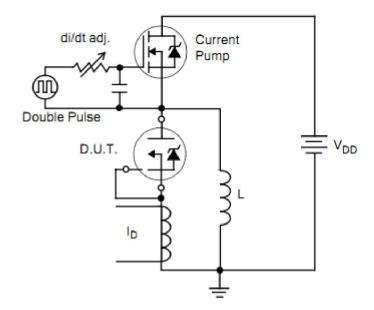
Figure 12. Gate Charge Waveforms











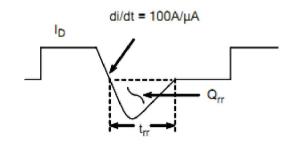


Figure 15. Diode Reverse Recovery Test Circuit

Figure 16. Diode Reverse Recovery Waveform

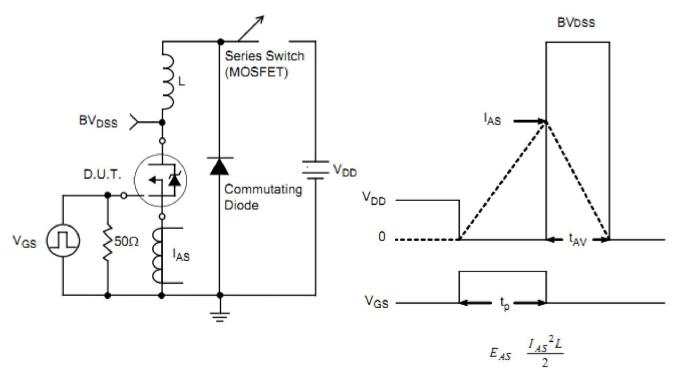


Figure 17. Unclamped Inductive Switching Test Circuit Figure 18. Unclamped Inductive Switching Waveform



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